

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP0114AS uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

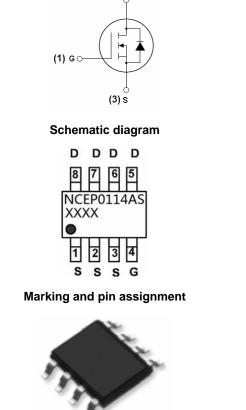
V_{DS} =100V,I_D =14A
R_{DS(ON)}=8.8mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=9.8mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!



(2) D

SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP0114AS	NCEP0114AS	SOP-8	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	14	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	10	А	
Pulsed Drain Current	I _{DM}	56	А	
Maximum Power Dissipation	PD	3.5	W	
Derating factor		0.028	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	196	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	





NCEP0114AS

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient ^(Note 2)	R _{0JA}	36	°C/W
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Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.0	1.7	2.2	V
	_	V _{GS} =10V, I _D =14A	-	8.8	11	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =14A	-	9.8	13	mΩ
Forward Transconductance	g _{FS}	V _{DS} =10V,I _D =14A	45	-	-	S
Dynamic Characteristics (Note4)						L
Input Capacitance	C _{lss}		-	4200	5480	PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,	-	354	425	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	23	30	PF
Switching Characteristics (Note 4)			1			
Turn-on Delay Time	t _{d(on)}		-	14	-	nS
Turn-on Rise Time	tr	V _{DD} =50V,I _D =14A	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	39	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg		-	58	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =50V,I _D =14A,	-	15	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	7.8	-	nC
Drain-Source Diode Characteristics						L
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =14A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		_	-	14	А
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-	101	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	193	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t \leq 10 sec.
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ \!\! C$,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25\Omega

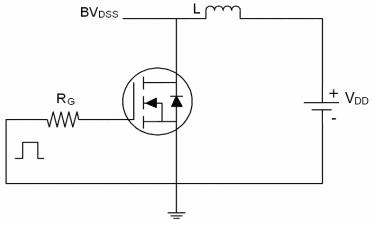


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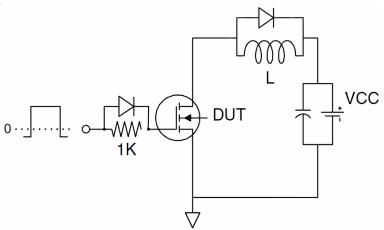




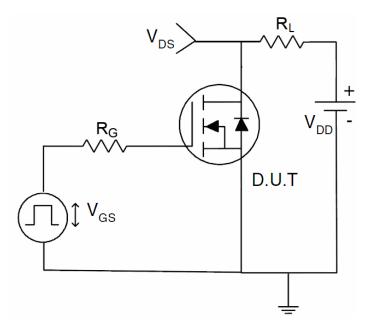
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





100

50

0.8

1.0

60

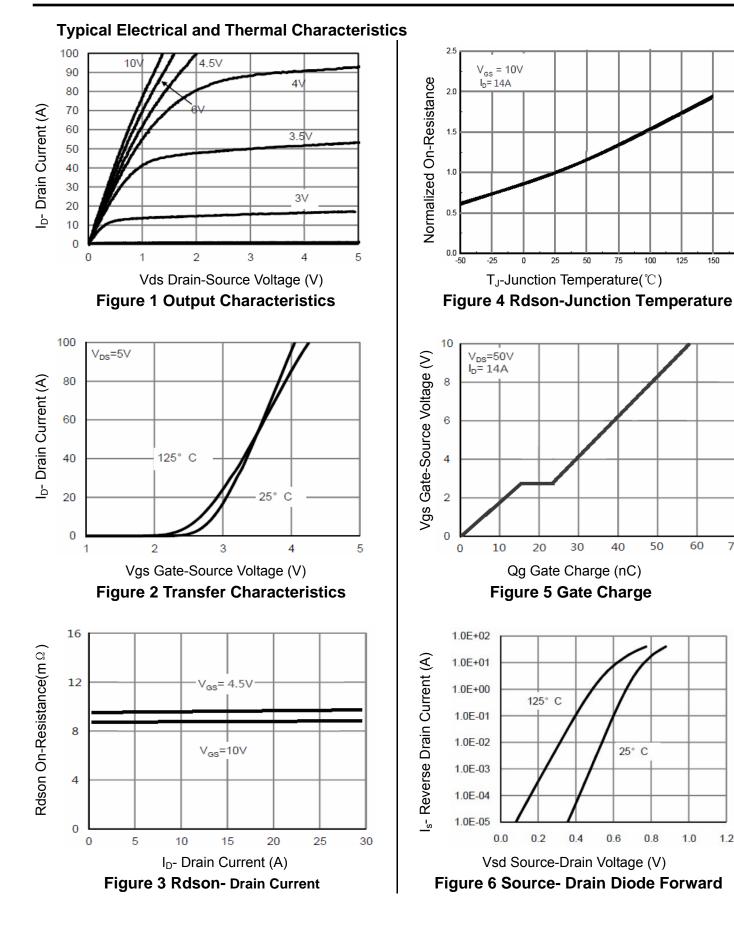
70

125

150

175





1.2



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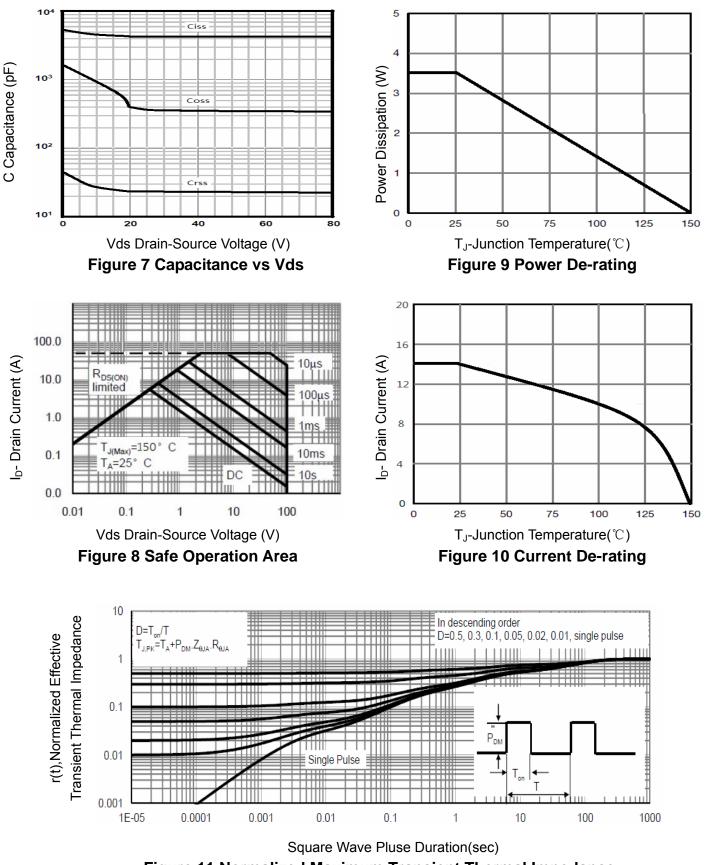


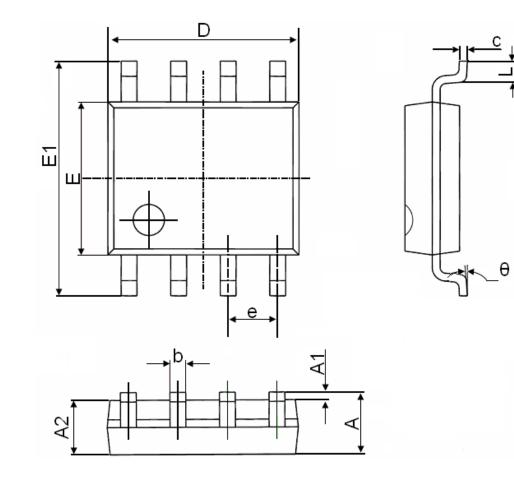
Figure 11 Normalized Maximum Transient Thermal Impedance



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SOP-8 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	





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